

**DESCRIPTION**

The AM3095 is available in the SOT-89 Package.

V _{DS}	R _{DS(on)}	I _D
-30V	45mΩ	-5A

APPLICATIONS

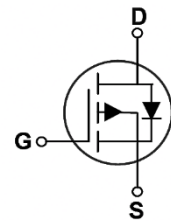
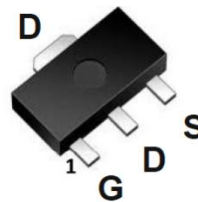
- Notebook
- Load Switch
- Hand-Held Instruments
- Battery Power Management

ORDERING INFORMATION

Package Type	Part Number	
SOT-89 SPQ:1,000pcs/Reel	K3	AM3095K3R
		AM3095K3VR
Note	V: Halogen free Package R: Tape & Reel	
AiT provides all RoHS products		

FEATURES

- -30V, -5A
R_{DS(ON)} Typ. = 45mΩ @ V_{GS} = -10V
R_{DS(ON)} Typ. = 59mΩ @ V_{GS} = -4.5V
- Fast Switching
- Excellent R_{DS(ON)} and Low Gate Charge
- Green Device available

PIN DESCRIPTION

Pin#	Symbol	Function
1	G	Gate
2	D	Drain
3	S	Source

ABSOLUTE MAXIMUM RATINGS

T_J=25°C, unless otherwise Noted

V _{DS} , Drain-to-Source Voltage		-30V
V _{GS} , Gate-to-Source Voltage		±12V
I _D , Continue Drain Current	T _C =25°C	-5A
	T _C =70°C	-3A
I _{DM} , Pulsed Drain Current ⁽¹⁾		-15.4A
E _{AS} , Single Pulse Avalanche Energy ⁽²⁾		64mJ
P _D , Power Dissipation	T _C =25°C	1.56W
R _{θJC} , Thermal Resistance, Junction to Case		80 °C/W
T _J , Operating Junction Temperature Range		-55°C~+150°C
T _{STG} , Storage Temperature Range		-55°C~+150°C

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



ELECTRICAL CHARACTERISTICS

T_J = 25°C, unless otherwise Noted

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Off Characteristic						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	-30	-	-	V
V _{(BR)DSS} Temperature Coefficient	ΔV _{DSS} /ΔT _J	I _D =1mA	-	-0.03	-	
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V	-	-	-1	μA
		V _{DS} =-24V, V _{GS} =0V T _J =125°C	-	-	-10	
Gate-Body Leakage Current	I _{GSS}	V _{DS} = 0V, V _{GS} =±12V	-	-	±100	nA
On Characteristic						
Static Drain-Source ON-Resistance *	R _{DS(ON)}	V _{GS} =10V, I _D =-4A	-	45	59	mΩ
		V _{GS} =-4.5V, I _D =-3A	-	59	74	
		V _{GS} =-2.5V, I _D =-2A		82	97	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.4	-0.8	-1.3	V
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)}		-	3	-	mV/°C
Forward Transconductance	g _{fs}	V _{DS} =-10V, I _D =-3A		5.4		S
Dynamic Characteristic						
Input Capacitance	C _{iss}	V _{DS} =-15V, V _{GS} =0V, f=1MHz	-	810	-	pF
Output Capacitance	C _{oss}		-	85	-	
Reverse Transfer Capacitance	C _{rss}		-	50	-	
Total Gate Charge	Q _G	V _{DS} = -15V, I _D =4A, V _{GS} = -4.5V	-	8	-	nC
Gate-Source charge	Q _{gS}		-	1.9	-	
Gate-Drain charge	Q _{gd}		-	1.4	-	
Switching Characteristic						
Turn-On Delay Time	t _{d(on)}	V _{DD} = -15V, R _{GEN} =6Ω V _{GS} = -10V, I _D =1A	-	5.4	-	ns
Rise Time	t _r		-	19.4	-	
Turn-Off Delay Time	t _{d(off)}		-	45.9		
Fall Time	t _f		-	12.4	-	
Drain-Source Diode Characteristics and Max Ratings						
Continuous Source Current	I _S	V _G =V _D =0V, Force Current	-	-	-5.0	A
Pulsed Source Current	I _{SM}		-	-	-15.4	
Drain to Source Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1A	-	-	-1.3	V
Body Diode Reverse Recovery Time	t _{rr}	I _F =30A, di/dt=100A/μs	-	115	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	150	-	nC

* Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.



TYPICAL PERFORMANCE CHARACTERISTICS

Fig 1. Output Characteristics

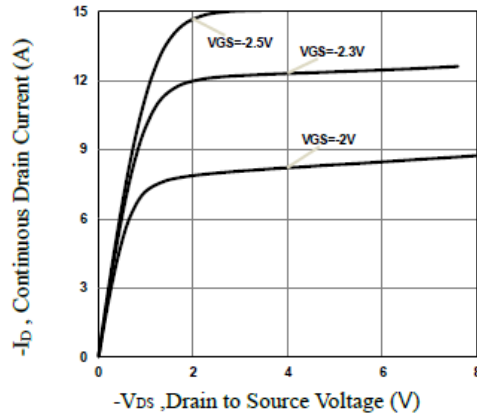


Fig 2. Typical Transfer Characteristics

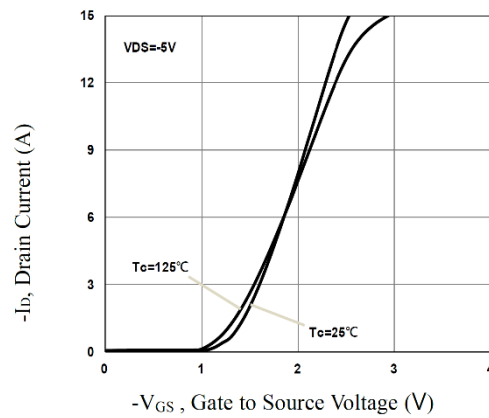


Fig 3. On-Resistance vs. Drain Current

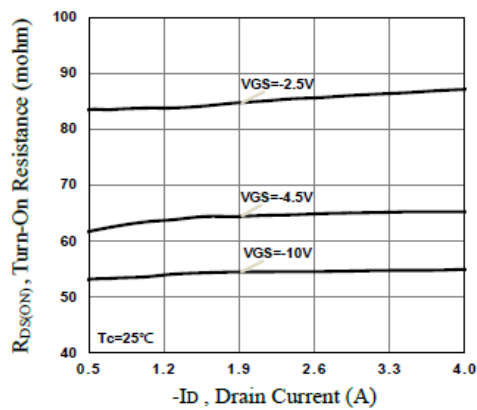


Fig 4. Turn-On Resistance vs. V_{GS}

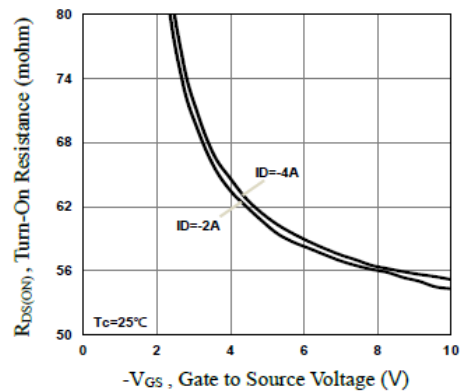


Fig 5. Gate Charge Characteristics

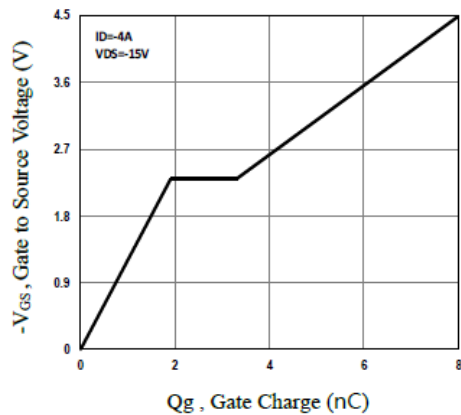


Fig 6. Capacitance Characteristics

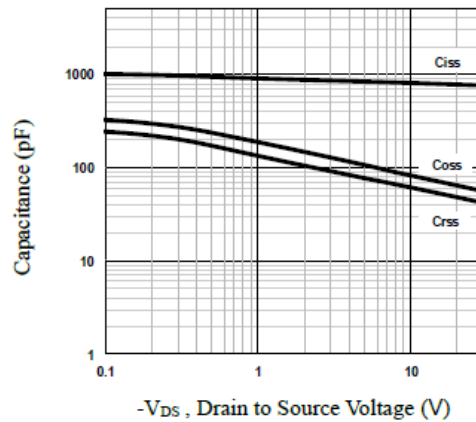




Fig 7. Normalized $V_{GS(th)}$ vs. T_J

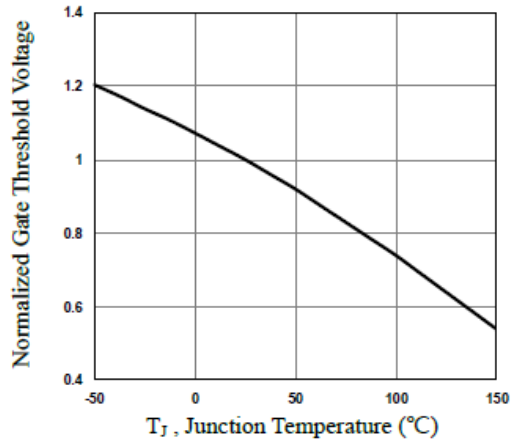


Fig 8. Normalized On-Resistance vs. T_J

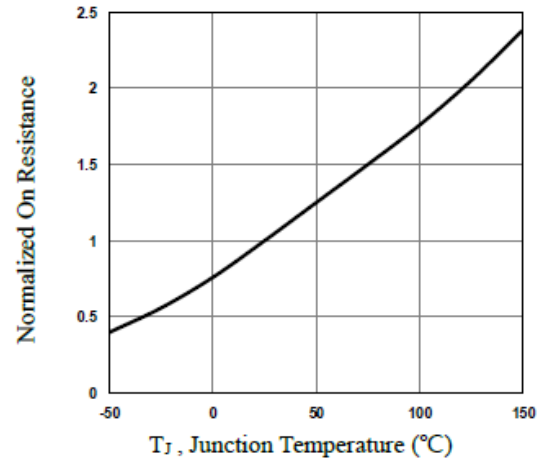


Fig 9. Maximum Safe Operating Area

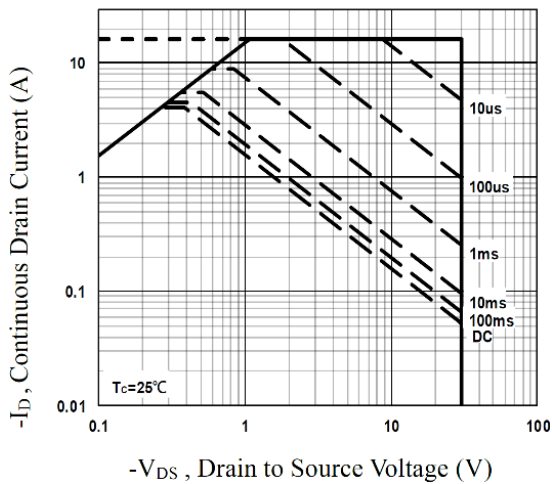


Fig 10. Maximum Continuous Drain Current vs. Case Temperature

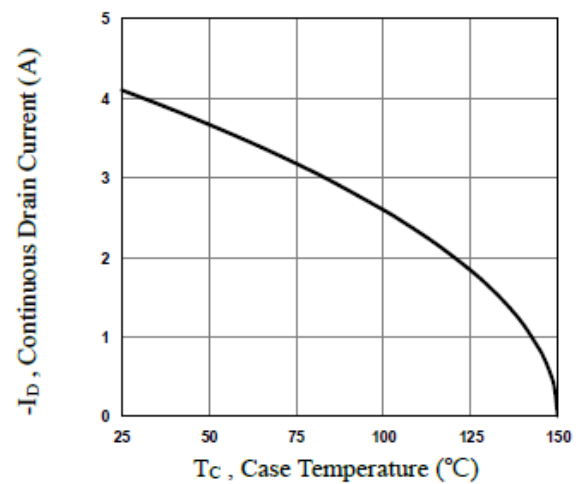
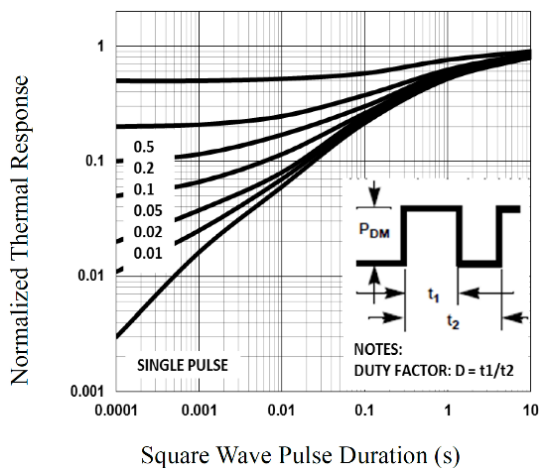


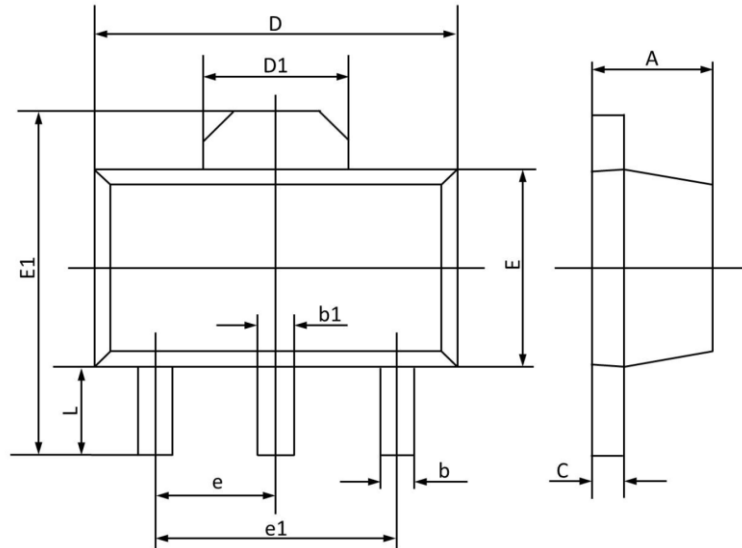
Fig 11. Normalized Maximum Transient Thermal Impedance





PACKAGE INFORMATION

Dimension in SOT-89(Unit: mm)



Symbol	Millimeter	
	Min.	Max.
A	1.400	1.600
b	0.320	0.520
b1	0.400	0.580
C	0.350	0.440
D	4.400	4.600
D1	1.550 REF	
E	2.300	2.600
E1	3.940	4.250
e	1.500 TYP.	
e1	3.000 TYP.	
L	0.900	1.200



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